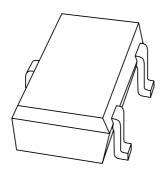
DISCRETE SEMICONDUCTORS

DATA SHEET



PMSS3906 PNP switching transistor

Product specification Supersedes data of 1999 Apr 22 2004 Jan 09





PNP switching transistor

PMSS3906

FEATURES

- Low current (max. 100 mA)
- Low voltage (max. 40 V).

APPLICATIONS

 Switching, e.g. telephony and professional communication equipment.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	-40	V
I _C	collector current	_	-100	mA
h _{FE}	DC current gain	100	300	

DESCRIPTION

PNP switching transistor in an SOT323 (SC-70) plastic package. NPN complement: PMSS3904.

PRODUCT OVERVIEW

TYPE NUMBER PACKAGE MARKIN		MARKING CODE(1)	NPN COMPLEMENT	
I TPE NUMBER	PHILIPS	EIAJ	MARKING CODE	NEW CONFERMENT
PMSS3906	SOT323	SC-70	06*	PMSS3904

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TVDE NUMBER	CIMPLIFIED OUTLINE AND CVMDOL		PINNING		
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION		
PMSS3906	3	1	base		
	3	2	emitter		
	Top view MAM048	3	collector		

PNP switching transistor

PMSS3906

ORDERING INFORMATION

TYPE NUMBER		PACKAGE			
NAME DESCRIPTION		DESCRIPTION	VERSION		
PMSS3906	_	plastic surface mounted package; 3 leads	SOT323		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-40	V
V _{CEO}	collector-emitter voltage	open base	_	-40	V
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-100	mA
I _{CM}	peak collector current		_	-200	mA
I _{BM}	peak base current		_	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; notes 1 and 2	_	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Transistor mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	notes 1 and 2	625	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Transistor mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.

PNP switching transistor

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

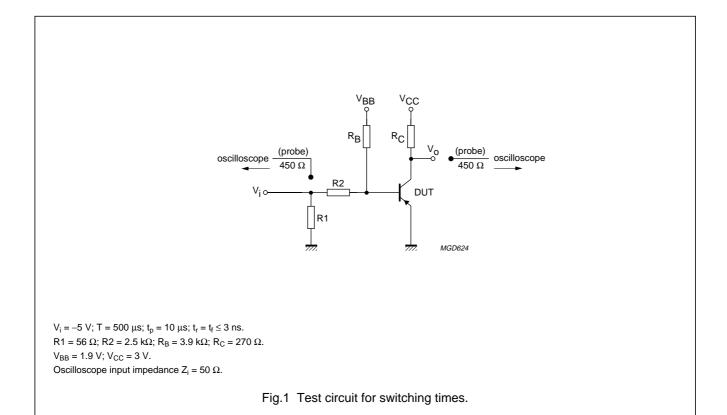
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	I _E = 0; V _{CB} = -30 V	_	-50	nA
		I _E = 0; V _{CB} = -30 V; T _j = 150 °C	_	-10	μΑ
I _{EBO}	emitter-base cut-off current	$I_C = 0; V_{EB} = -5 \text{ V}$	_	-50	nA
h _{FE}	DC current gain	V _{CE} = -1 V			
		$I_{C} = -0.1 \text{ mA}$	60	_	
		$I_C = -1 \text{ mA}$	80	_	
		$I_C = -10 \text{ mA}$	100	300	
		$I_C = -50$ mA; note 1	60	_	
		$I_{\rm C} = -100 \text{ mA}$; note 1	30	_	
V _{CEsat}	collector-emitter saturation	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-250	mV
	voltage	$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-400	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	_	-850	mV
		$I_C = -50 \text{ mA}$; $I_B = -5 \text{ mA}$; note 1	_	-950	mV
C _c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = -5 \text{ V}$; $f = 1 \text{ MHz}$	_	4.5	pF
C _e	emitter capacitance	$I_C = I_C = 0$; $V_{EB} = -0.5 \text{ V}$; $f = 1 \text{ MHz}$	_	14	pF
f _T	transition frequency	$I_E = -10 \text{ mA}; V_{CB} = -20 \text{ V}; f = 100 \text{ MHz}$	150	_	MHz
F	noise figure	I_C = -100 μA; V_{CE} = -5 V; R_S = 1 kΩ; f = 10 Hz to 15.7 kHz	_	4	dB
Switching ti	mes (between 10% and 90% lev	els); see Fig.1			
t _{on}	turn-on time	$I_{Con} = -10 \text{ mA}; I_{Bon} = -1 \text{ mA};$	_	100	ns
t _d	delay time	I _{Boff} = 1 mA	_	50	ns
t _r	rise time		_	50	ns
t _{off}	turn-off time		_	700	ns
t _s	storage time		_	600	ns
t _f	fall time		_	100	ns

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

PNP switching transistor

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PNP switching transistor

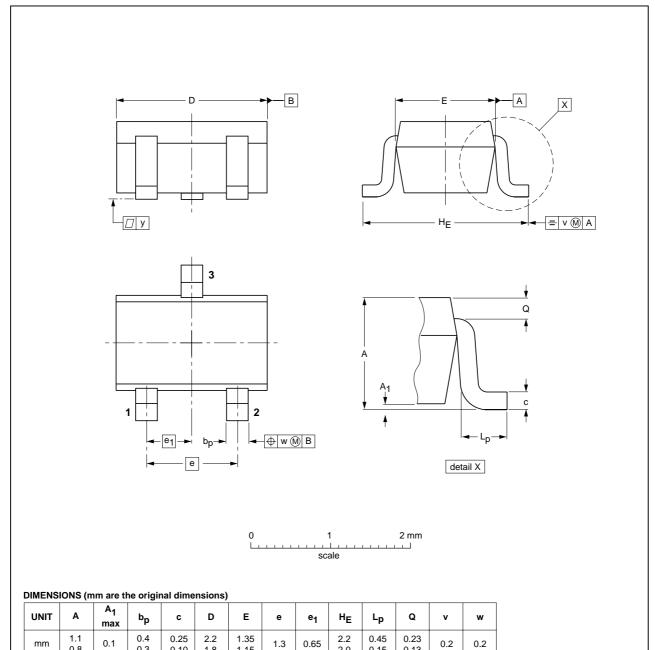
PMSS3906

PACKAGE OUTLINE

mm

Plastic surface mounted package; 3 leads

SOT323



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT323			SC-70			97-02-28

2004 Jan 09 6

0.3

0.10

PNP switching transistor

PMSS3906

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Notes

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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